

## Small Signal Product

### Features

- ◇ Fast switching device( $T_{rr}<4.0\text{ns}$ )
- ◇ Surface device type mounting
- ◇ Moisture sensitivity level 1
- ◇ Matte Tin(Sn) lead finish with Nickel(Ni) underplate
- ◇ Pb free version and RoHS compliant
- ◇ Green compound (Halogen free) with suffix "G" on packing code and prefix "G" on date code

### SOD-323F



### Mechanical Data

- ◇ Case : Flat lead SOD-323F small outline plastic package
- ◇ Terminal : Matte tin plated, solderable  
per MIL-STD-202, method 208 guaranteed
- ◇ High temperature soldering guaranteed :  $260^{\circ}\text{C}/10\text{s}$
- ◇ Polarity : Indicated by cathode band
- ◇ Weight :  $4.85 \pm 0.5 \text{ mg}$
- ◇ Marking Code : S1, S2, S3



### Ordering Information (example)

| Part No. | Package  | Packing      | Packing code | Packing code (Green) | Manufacture code |
|----------|----------|--------------|--------------|----------------------|------------------|
| 1N4148WS | SOD-323F | 3K / 7" Reel | RR           | RRG                  |                  |

Note : Detail please see "Ordering Information(detail, example)" below.

### Maximum Ratings and Electrical Characteristics

Rating at  $25^{\circ}\text{C}$  ambient temperature unless otherwise specified.

#### Maximum Ratings

| Parameter                                | Symbol          | Value        | Units                       |
|------------------------------------------|-----------------|--------------|-----------------------------|
| Power Dissipation                        | $P_D$           | 200          | mW                          |
| Non-Repetitive Peak Reverse Voltage      | $V_{RM}$        | 100          | V                           |
| Repetitive Peak Reverse Voltage          | $V_{RRM}$       | 75           | V                           |
| Reverse Voltage                          | $V_R$           | 100          | V                           |
| Non-Repetitive Peak Forward Current      | $I_{FRM}$       | 300          | mA                          |
| Mean Forward Current                     | $I_O$           | 150          | mA                          |
| Thermal Resistance (Junction to Ambient) | $R_{\theta JA}$ | 625          | $^{\circ}\text{C}/\text{W}$ |
| Junction and Storage Temperature Range   | $T_J, T_{STG}$  | -65 to + 150 | $^{\circ}\text{C}$          |

#### Electrical Characteristics

| Parameter                                                                                     | Symbol     | Min            | Max                | Units               |
|-----------------------------------------------------------------------------------------------|------------|----------------|--------------------|---------------------|
| Reverse Breakdown Voltage<br>$I_R=100\mu\text{A}$<br>$I_R=5\mu\text{A}$                       | $V_{(BR)}$ | 100<br>75      | -<br>-             | V                   |
| Forward Voltage<br>1N4448WS, 1N914BWS<br>1N4148WS<br>1N4448WS, 1N914BWS                       | $V_F$      | 0.62<br>-<br>- | 0.72<br>1.0<br>1.0 | V                   |
| Reverse Leakage Current<br>$V_R=20\text{V}$<br>$V_R=75\text{V}$                               | $I_R$      | -<br>-         | 25<br>5.0          | nA<br>$\mu\text{A}$ |
| Junction Capacitance<br>$V_R=0, f=1.0\text{MHz}$                                              | $C_J$      | -              | 4.0                | pF                  |
| Reverse Recovery Time<br>$I_F=10\text{mA}, I_R=60\text{mA}, R_L=100\Omega, I_{RR}=1\text{mA}$ | $T_{rr}$   | -              | 4.0                | ns                  |

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### RATINGS AND CHARACTERISTIC CURVES

Fig. 1 Forward Voltage VS. Forward Current

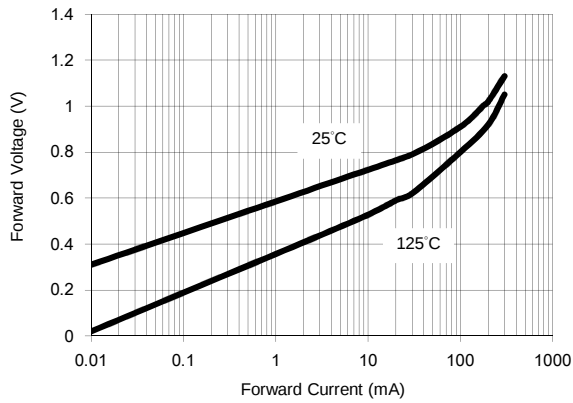


Fig. 2 Reverse Current vs Reverse Voltage

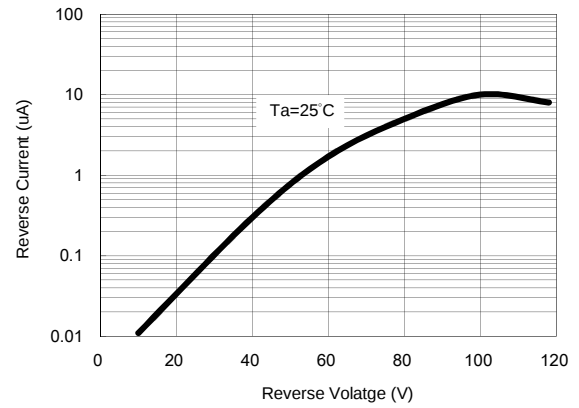


Fig. 3 Admissible Power Dissipation Curve

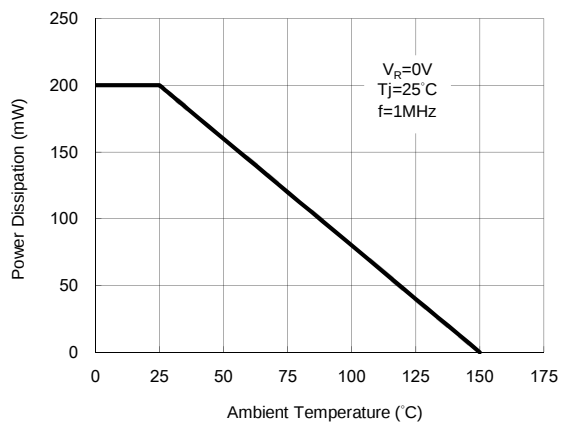
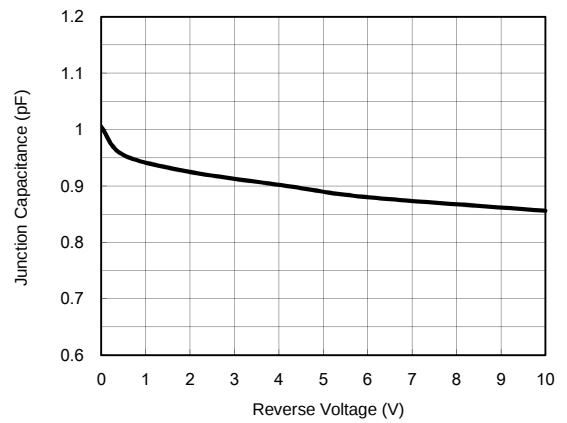


Fig. 4 Typical Junction Capacitance



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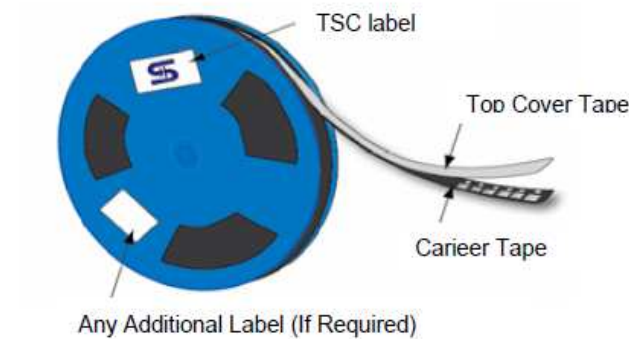
### Ordering information (Detail, example)

| Part No.             | Package | Packing      | Packing code | Packing code (Green) | Manufacture code |
|----------------------|---------|--------------|--------------|----------------------|------------------|
| 1NxxxxWS<br>(Note 1) | SOD-323 | 3K / 7" Reel | RR           | RRG                  | (Note 2)         |
|                      |         | 3K / 7" Reel | RQ           | RQG                  |                  |
| 1N4148WS             | SOD-323 | 3K / 7" Reel | RR           | RRG                  |                  |
| 1N4148WS             | SOD-323 | 3K / 7" Reel | RR           | RRG                  |                  |

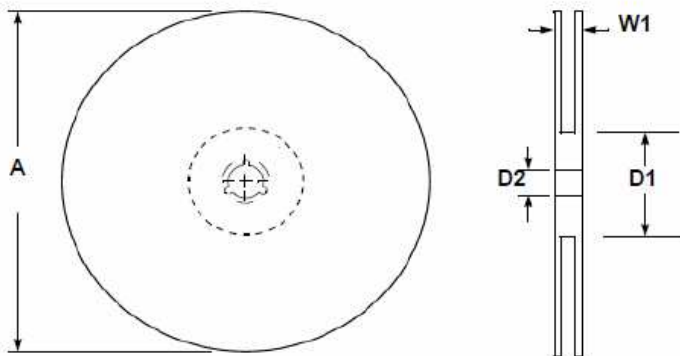
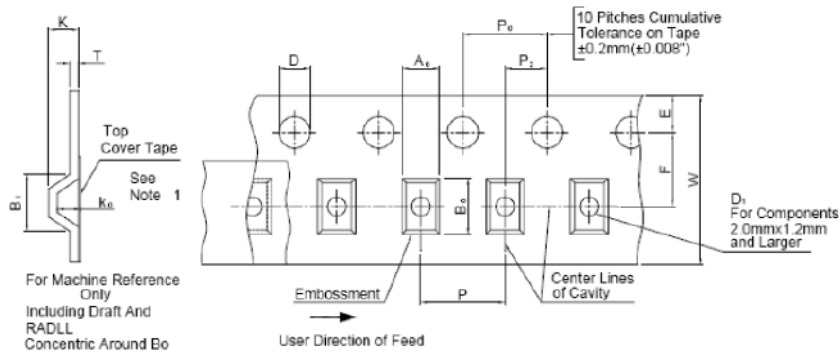
Note 1 : "xxxx" is Device Code from "4148" to "914B".

Note 2 : Manufacture special control, if empty means no special control requirement.

### Tape & Reel specification



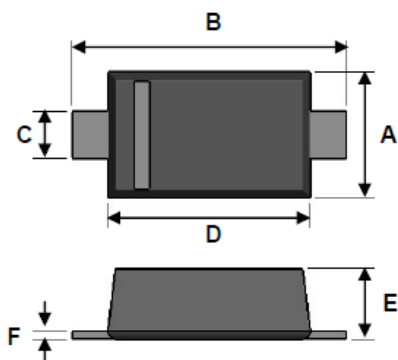
| Item                   | Symbol | Dimension(mm) |
|------------------------|--------|---------------|
| Carrier depth          | K      | 2.40 Max.     |
| Sprocket hole          | D      | 1.5 ± 0.1     |
| Reel outside diameter  | A      | 178 ± 1       |
| Reel inner diameter    | D1     | 50 Min.       |
| Feed hole width        | D2     | 13.0 ± 0.5    |
| Sprocket hole position | E      | 1.75 ± 0.10   |
| Punch hole position    | F      | 3.50 ± 0.05   |
| Sprocket hole pitch    | P0     | 4.00 ± 0.10   |
| Embossment center      | P1     | 2.00 ± 0.10   |
| Overall tape thickness | T      | 0.6 Max.      |
| Tape width             | W      | 8.30 Max.     |
| Reel width             | W1     | 14.4 Max      |



Note 1 :  $A_0$ ,  $B_0$ , and  $K_0$  are determined by component size. The clearance between the components and the cavity must be within 0.05 mm min. to 0.5 mm max. The component cannot rotate more than  $10^\circ$  within the determined cavity.

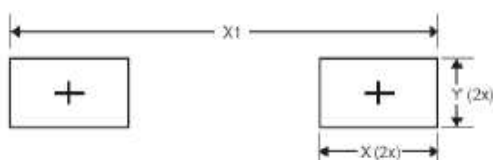
Note 2 : If  $B_1$  exceeds 4.2mm(0.165") for 8 mm embossed tape, the tape may not feed through all tape feeders.

## Dimensions



| DIM. | Unit (mm) |      | Unit (inch) |       |
|------|-----------|------|-------------|-------|
|      | Min       | Max  | Min         | Max   |
| A    | 1.15      | 1.35 | 0.045       | 0.053 |
| B    | 2.30      | 2.80 | 0.091       | 0.110 |
| C    | 0.25      | 0.40 | 0.010       | 0.016 |
| D    | 1.60      | 1.80 | 0.063       | 0.071 |
| E    | 0.80      | 1.10 | 0.031       | 0.043 |
| F    | 0.05      | 0.25 | 0.002       | 0.010 |

## Suggested PAD Layout



| DIM. | Unit(mm) | Unit(inch) |
|------|----------|------------|
|      | Typ.     | Typ.       |
| X    | 0.710    | 0.028      |
| X1   | 2.900    | 0.114      |
| Y    | 0.403    | 0.016      |

## Marking

| Part No. | Marking |
|----------|---------|
| 1N4148WS | S1      |
| 1N4448WS | S2      |
| 1N914BWS | S3      |

Note : 1. The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application.

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